



To:

John D' Ambrosia, Chair 802.3 HSSG
Bob Grow, Chair 802.3

From:

Jim Jones, Chair, OIF Technical Committee
David Stauffer, Chair, OIF Physical Layer WG

As you may know, we are working on a project known as Common Electrical Interface, 25 Gb/s (CEI-25) whose aim is to define a high speed electrical interface useful in both chip-to-chip and backplane applications. CEI-25 may be of eventual use by the 802.3 HSSG in the definition of a 4 or 5 lane PMD. It should be noted that our earlier CEI-11G Interoperability Agreement was used as input to the 802.3ap project and was hopefully of assistance to that project.

We have received a presentation on a credible signaling approach for this project at our October 2006 meeting. We intend to accept final presentations for signaling approaches at our January 22-26, 2007 meeting in Milpitas, California and select a technical direction at our April 23-27, 2007 meeting. We would welcome input from OIF member companies or IEEE 802.3 liaison on potential signaling approaches at our January meeting.

Best regards,

A handwritten signature in cursive script that reads "James D. Jones".

Jim Jones
OIF Technical Committee Chair